



# Product Change Notification

## 113703 - 00

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# Product Change Notification

**Change Notification #:** 113703 - 00  
**Change Title:** Intel® Server Rail Kits AXXPRAIL and AXXPRAIL755  
PCN 113703-00, Product Design Upgrade Server Rail Kits  
**Date of Publication:** March 10, 2015

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material *:</b>	March 25, 2015
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

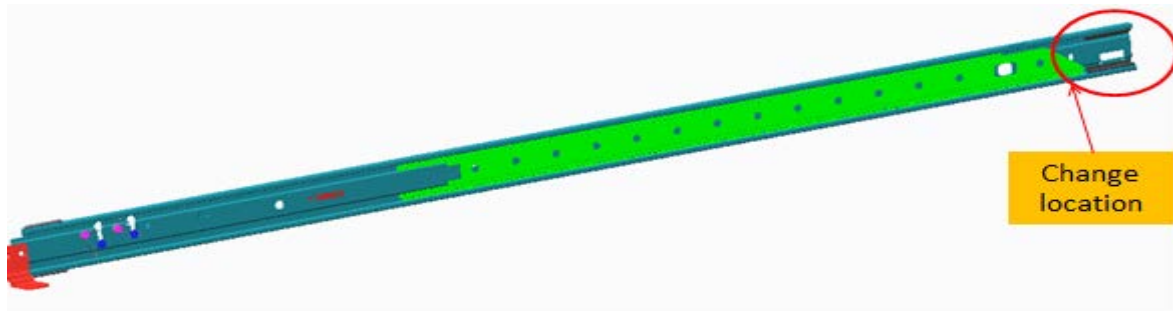
## Description of Change to the Customer:

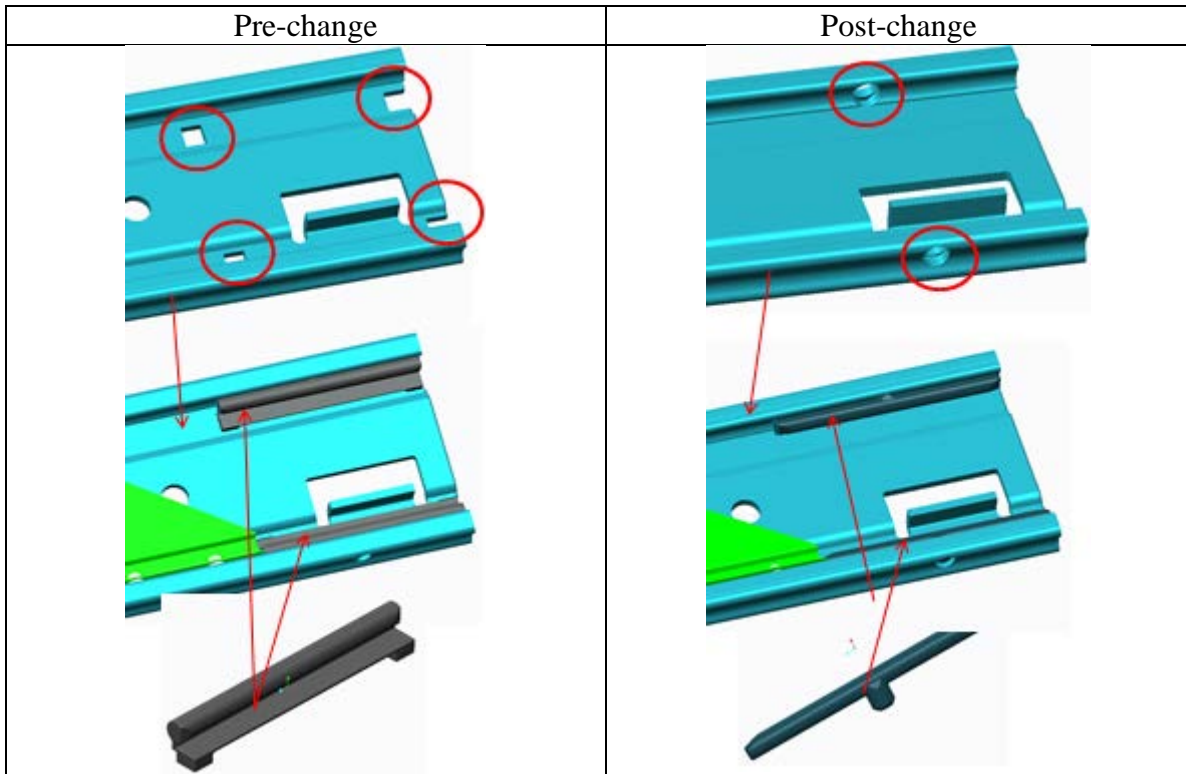
Intel is implementing the following change on the Intel® Server Rail Kits AXXPRAIL and AXXPRAIL755:

Upgrade the AXXPRAIL and AXXPRAIL755 to improve the stability of the aluminum guide blocks and assembly flexibility.

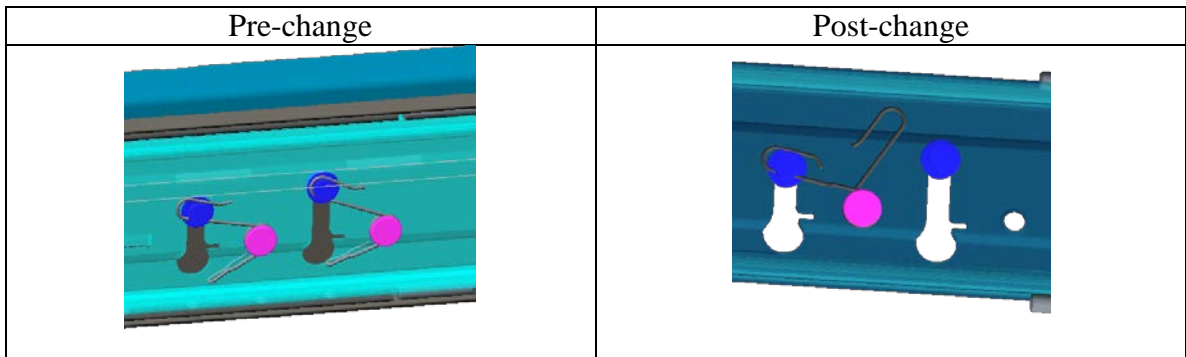
1. Update the Guide blocks.

Location of Rails





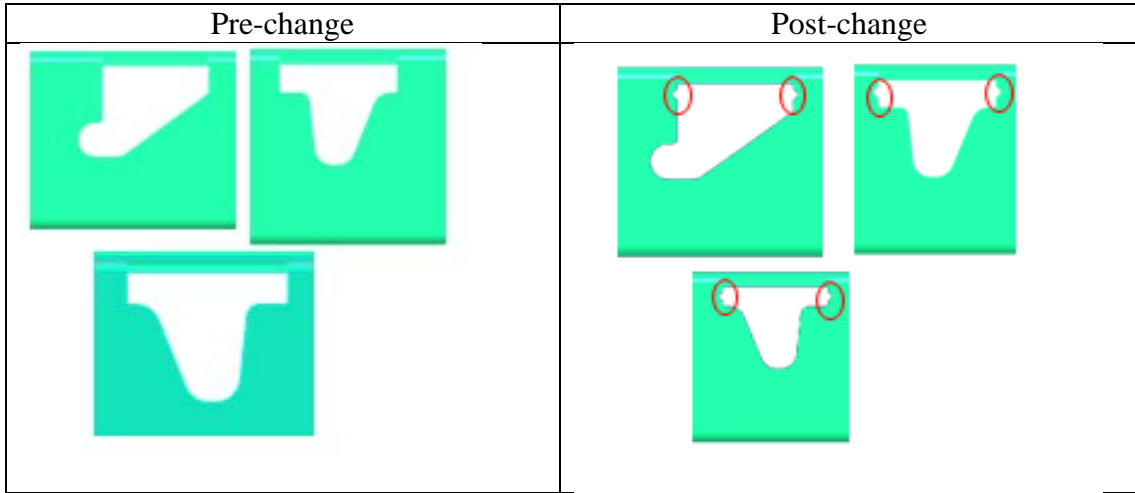
2. Update the Stage lock.



3. Update the inner member.

Location of slots. Increase the J slot cutouts to help eliminate burrs during stamping process.





**Customer Impact of Change and Recommended Action:**

Intel does not expect any impact to customers from these changes. Customers may need to validate the function and feature changes once the post-change system is available.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change TA	Post Change TA
AXXPRAIL	924417	G34101-005	G34101-006
AXXPRAIL755	924418	G64604-003	G64604-004

**PCN Revision History:**

**Date of Revision:**

March 10, 2015

**Revision Number:**

00

**Reason:**

Originally Published PCN